

Title (en)
METHOD AND DEVICE FOR COOLING THE COPPER PLATES OF A CONTINUOUS CASTING INGOT MOULD FOR LIQUID METALS,
ESPECIALLY LIQUID STEEL

Title (de)
VERFAHREN UND EINRICHTUNG ZUM KÜHLEN DER KUPFERPLATTEN EINER STRANGGIESSKOKILLE FÜR FLÜSSIGE METALLE,
INSBESONDERE FÜR FLÜSSIGEN STAHL

Title (fr)
PROCEDE ET DISPOSITIF DE REFOIDISSEMENT DES PLAQUES DE CUIVRE D'UNE COQUILLE POUR LA COULEE CONTINUE DE METAUX
LIQUIDES, EN PARTICULIER D'ACIER LIQUIDE

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Priority

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Abstract (en)
[origin: WO03028921A2] The invention relates to a device for cooling the copper plates (1.1) of a continuous casting ingot mould (1) for liquid metals, especially liquid steel, comprising an ingot mould coolant (2) which is guided in cooling channels. During the initial temperature rise to achieve a set casting speed or when said casting speed is exceeded for a deviating copper plate skin temperature (8), the copper plate skin temperature (8) is influenced, even when the casting speed is higher, in such a way that surface errors in the casting shell and/or cracks in the surface of the copper plates are prevented from occurring or occur in a significantly reduced manner by adjusting the copper plate skin temperature (8) at alternating casting speeds (6) of between 1 m / min and a maximum 12 m / min by means of quantitative correction of the amount of ingot mould coolant (4) and/or ingot mould coolant inflow temperature (5) according to the casting speed (6) and according to the thickness of the copper plates (9), to a desired constant value.

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